



OPA343 OPA2343 OPA4343

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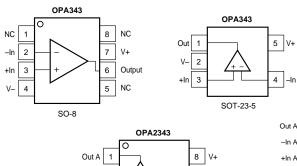
# SINGLE-SUPPLY, RAIL-TO-RAIL OPERATIONAL AMPLIFIERS *microAmplifier*™ Series

## **FEATURES**

- RAIL-TO-RAIL INPUT/OUTPUT
- MICRO SIZE PACKAGES
- WIDE BANDWIDTH: 5.5MHz
   HIGH SLEW RATE: 6V/µs
- LOW THD+NOISE: 0.0007% (f = 1kHz) ● LOW QUIESCENT CURRENT: 850µA/chan ● SINGLE, DUAL, AND QUAD VERSIONS

## **DESCRIPTION**

OPA343 series rail-to-rail CMOS operational amplifiers are designed for low-cost, miniature applications. They are optimized for low-voltage, single-supply operation. Rail-to-rail input/output and high-speed operation make them ideal for driving sampling Analog-to-Digital (A/D) converters. They are also well suited for general-purpose and audio applications as well as providing I/V conversion at the output of Digital-to-Analog (D/A) converters. Single, dual, and quad versions have identical specifications for design flexibility.



SO-8, MSOP-8

Out B

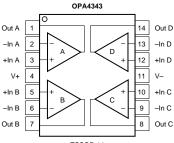
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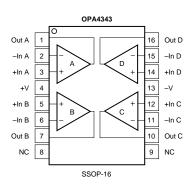
## **APPLICATIONS**

- DRIVING A/D CONVERTERS
- PCMCIA CARDS
- **DATA ACQUISITION**
- AUDIO PROCESSING
- COMMUNICATIONS
- ACTIVE FILTERS
- TEST EQUIPMENT

The OPA343 series operates on a single supply as low as 2.5V, and input common-mode voltage range extends 500mV beyond the supply rails. Output voltage swings to within 1mV of the supply rails with a 100k $\Omega$  load. They offer excellent dynamic response (BW = 5.5MHz, SR = 6V/ $\mu$ s), yet quiescent current is only 850 $\mu$ A. Dual and quad designs feature completely independent circuitry for lowest crosstalk and freedom from interaction.

The single (OPA343) packages are the tiny SOT-23-5 surface mount and SO-8 surface mount. The dual (OPA2343) comes in the miniature MSOP-8 surface mount and SO-8 surface mount. The quad (OPA4343) packages are the space-saving SSOP-16 surface mount, SO-14 surface mount, and TSSOP-14 surface mount. All are specified from -40°C to +85°C and operate from -55°C to +125°C. A SPICE macromodel is available for design analysis.







# SPECIFICATIONS: $V_S = 2.7V$ to 5.5V

Boldface limits apply over the specified temperature range,  $T_A = -40^{\circ}C$  to  $+85^{\circ}C$ .  $V_S = 5V$ .

At  $T_A$  = +25°C,  $R_L$  = 10k $\Omega$  connected to  $V_S/2$  and  $V_{OUT}$  =  $V_S/2$ , unless otherwise noted.

			OPA343NA, U OPA2343EA, U PA4343EA, UA	JA	
PARAMETER	CONDITION	MIN	TYP <sup>(1)</sup>	MAX	UNITS
OFFSET VOLTAGE Input Offset Voltage vs Temperature vs Power Supply Over Temperature Channel Separation, dc	Τ		±2 ±3 40	±8 200 <b>200</b>	mV μV/°C μV/V μV/V
Over Temperature	B S		±0.2 ±0.2	±10 ± <b>60</b> ±10	pA pA pA
NOISE Input Voltage Noise, f = 0.1 to 50kHz Input Voltage Noise Density, f = 1kHz Current Noise Density, f = 1kHz	in n		8 25 3		μVrms nV/√Hz fA/√Hz
INPUT VOLTAGE RANGE Common-Mode Voltage Range Voltage Range Common-Mode Rejection Ratio CMR		-0.3 74 60 54	92 75 70	(V+) + 0.3	V dB dB dB
INPUT IMPEDANCE Differential Common-Mode			10 <sup>13</sup>    3 10 <sup>13</sup>    6		Ω    pF Ω    pF
OPEN-LOOP GAIN Open-Loop Voltage Gain A Over Temperature Over Temperature	$R_{L} = 100k\Omega$ , $5mV < V_{O} < (V+) - 5mV$ $R_{L} = 100k\Omega$ , $5mV < V_{O} < (V+) - 5mV$ $R_{L} = 10k\Omega$ , $50mV < V_{O} < (V+) - 50mV$ $R_{L} = 10k\Omega$ , $50mV < V_{O} < (V+) - 50mV$ $R_{L} = 2k\Omega$ , $200mV < V_{O} < (V+) - 200mV$	100 <b>100</b> 100 <b>100</b> 92	120 117 110		dB dB dB dB
Over Temperature	$R_L = 2k\Omega$ , 200mV < $V_O$ < $(V+) - 200mV$	92			dB
FREQUENCY RESPONSE  Gain-Bandwidth Product GB  Slew Rate S  Settling Time, 0.1%  0.01%  Overload Recovery Time  Total Harmonic Distortion + Noise THD+	$ \begin{array}{cccccccccccccccccccccccccccccccccccc$		5.5 6 1 1.6 0.2 0.0007		MHz V/μs μs μs μs
OUTPUT Voltage Output Swing from Rail <sup>(3)</sup> Over Temperature Over Temperature  Over Temperature Short-Circuit Current Capacitive Load Drive  Color Temperature Color Colo	$\begin{aligned} R_L &= 100k\Omega,\ A_{OL} \geq 100dB \\ R_L &= 100k\Omega,\ A_{OL} \geq 100dB \\ R_L &= 10k\Omega,\ A_{OL} \geq 100dB \\ R_L &= 10k\Omega,\ A_{OL} \geq 100dB \\ R_L &= 2k\Omega,\ A_{OL} \geq 92dB \\ R_L &= 2k\Omega,\ A_{OL} \geq 92dB \end{aligned}$	S	1 10 40 ±50 ee Typical Cur	5 5 50 50 200 200	mV mV mV mV mV mA
Operating Voltage Range	$I_0 = 0, V_S = +5V$ $I_0 = 0, V_S = +5V$	2.7	2.5 to 5.5 0.85	5 1.25 <b>1.4</b>	V V mA mA
TEMPERATURE RANGE Specified Range Operating Range Storage Range Thermal Resistance SOT-23-5 Surface Mount MSOP-8 Surface Mount SO-8 Surface Mount SOP-16 Surface Mount SOP-14 Surface Mount TSSOP-14 Surface Mount	A	-40 -55 -65	200 150 150 100 100 125	+85 +125 +150	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0

NOTES: (1)  $V_S = +5V$ . (2)  $V_{OUT} = 0.25V$  to 3.25V. (3) Output voltage swings are measured between the output and power supply rails.



#### **ABSOLUTE MAXIMUM RATINGS(1)**

Supply Voltage	7.5V
Signal Input Terminals, Voltage(2)	(V-) -0.5V to (V+) +0.5V
Current <sup>(2)</sup>	10mA
Output Short-Circuit(3)	Continuous
Operating Temperature	55°C to +125°C
Storage Temperature	65°C to +150°C
Junction Temperature	150°C
Lead Temperature (soldering, 10s)	300°C

NOTES: (1) Stresses above these ratings may cause permanent damage. Exposure to absolute maximum conditions for extended periods may degrade device reliability. (2) Input terminals are diode-clamped to the power supply rails. Input signals that can swing more than 0.5V beyond the supply rails should be current-limited to 10mA or less. (3) Short-circuit to ground, one amplifier per package.



This integrated circuit can be damaged by ESD. Burr-Brown recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

#### **PACKAGE/ORDERING INFORMATION**

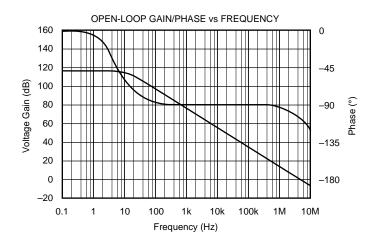
PRODUCT	PACKAGE	PACKAGE DRAWING NUMBER	SPECIFIED TEMPERATURE RANGE	PACKAGE MARKING	ORDERING NUMBER <sup>(1)</sup>	TRANSPORT MEDIA
Single OPA343NA " OPA343UA	5-Lead SOT-23-5	331 " 182	-40°C to +85°C -40°C to +85°C	B43 " OPA343UA	OPA343NA/250 OPA343NA/3K OPA343UA	Tape and Reel Tape and Reel Rails
UPA343UA "	30-6 Surface-Mount	102	-40 C to +65 C	UFA343UA "	OPA343UA/2K5	Tape and Reel
Dual						
OPA2343EA	MSOP-8 Surface-Mount	337	-40°C to +85°C	C43	OPA2343EA/250 OPA2343EA/2K5	Tape and Reel Tape and Reel
OPA2343UA	SO-8 Surface-Mount	182 "	-40°C to +85°C	OPA2343UA "	OPA2343UA OPA2343UA/2K5	Rails Tape and Reel
Quad						
OPA4343EA	SSOP-16 Surface-Mount	322 "	-40°C to +85°C	OPA4343EA "	OPA4343EA/250 OPA4343EA/2K5	Tape and Reel Tape and Reel
OPA4343UA	SO-14 Surfac-Mount	235	-40°C to +85°C	OPA4343UA "	OPA4343UA OPA4343UA/2K5	Rails Tape and Reel
OPA4343NA "	TSSOP-14 Surface-Mount	357 "	-40°C to +85°C	OPA4343NA "	OPA4343NA/250 OPA4343NA/2K5	Tape and Reel Tape and Reel

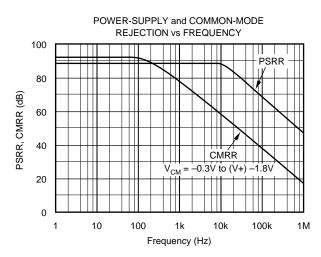
NOTE: (1) Models with a slash (/) are available only in Tape and Reel in the quantities indicated (e.g., /2K5 indicates 2500 devices per reel). Ordering 2500 pieces of "OPA2343EA/2K5" will get a single 2500 piece Tape and Reel.

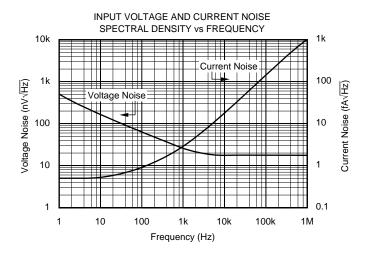
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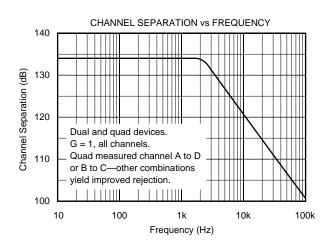


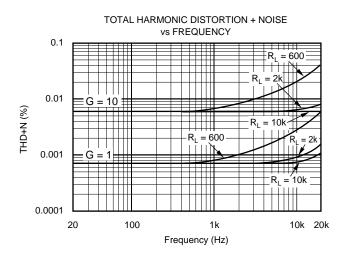
# TYPICAL PERFORMANCE CURVES

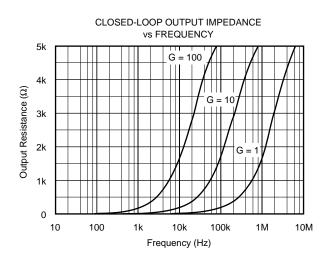






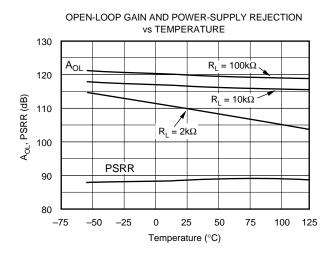


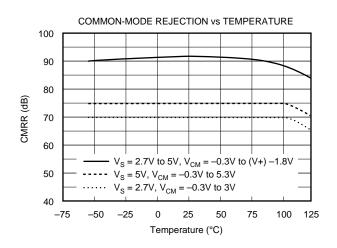


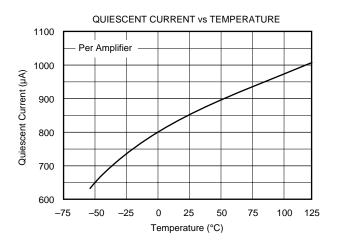


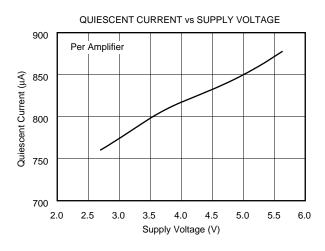


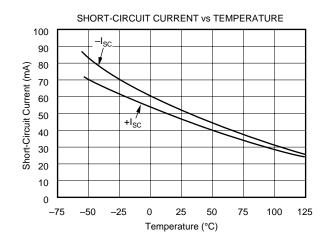
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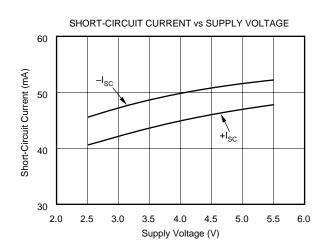






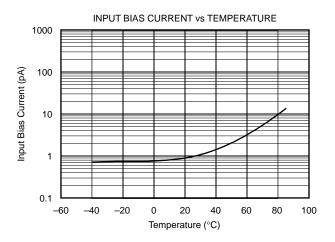


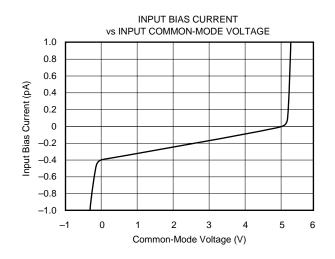


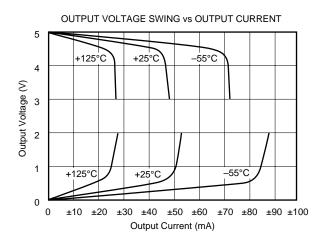


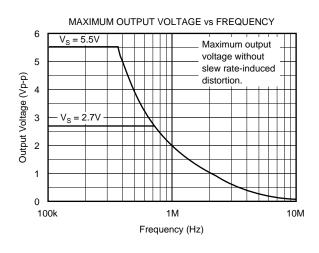


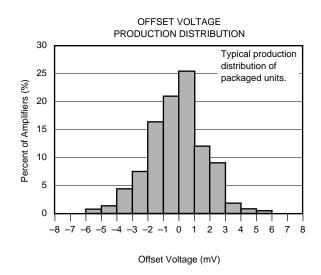
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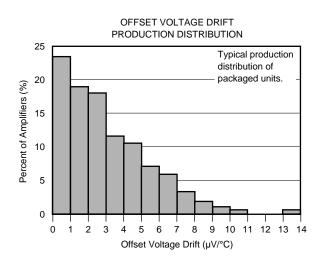






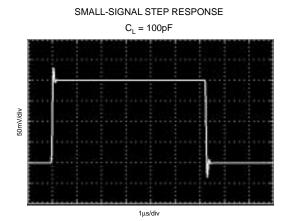


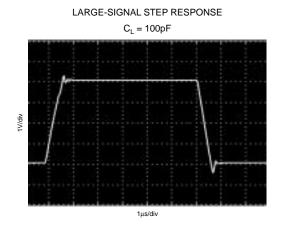


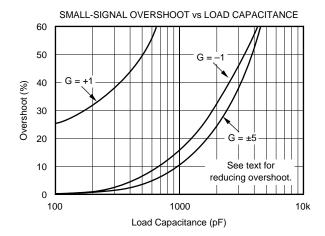


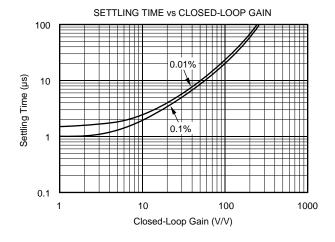


# **TYPICAL PERFORMANCE CURVES (Cont.)**









## APPLICATIONS INFORMATION

OPA343 series op amps are fabricated on a state-of-the-art 0.6 micron CMOS process. They are unity-gain stable and suitable for a wide range of general-purpose applications. Rail-to-rail input/output make them ideal for driving sampling A/D converters. In addition, excellent ac performance makes them well-suited for audio applications. The class AB output stage is capable of driving  $600\Omega$  loads connected to any point between V+ and ground.

Rail-to-rail input and output swing significantly increases dynamic range, especially in low-supply applications. Figure 1 shows the input and output waveforms for the OPA343 in unity-gain configuration. Operation is from a single +5V supply with a  $10k\Omega$  load connected to  $V_S/2$ . The input is a 5Vp-p sinusoid. Output voltage is approximately 4.98Vp-p.

Power-supply pins should be bypassed with  $0.01\mu F$  ceramic capacitors.

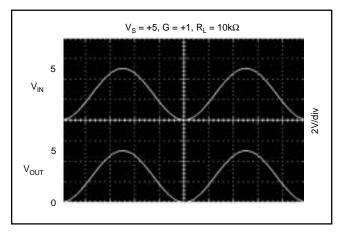


FIGURE 1. Rail-to-Rail Input and Output.

#### **OPERATING VOLTAGE**

OPA343 series op amps are fully specified from +2.7V to +5V. However, supply voltage may range from +2.5V to +5.5V. Parameters are guaranteed over the specified supply range—a unique feature of the OPA343 series. In addition, many specifications apply from -40°C to +85°C. Most behavior remains virtually unchanged throughout the full operating voltage range. Parameters which vary significantly with operating voltages or temperature are shown in the Typical Performance Curves.

#### **RAIL-TO-RAIL INPUT**

The input common-mode voltage range of the OPA343 series extends 500mV beyond the supply rails. This is achieved with a complementary input stage—an N-channel input differential pair in parallel with a P-channel differential pair, as shown in Figure 2. The N-channel pair is active for input voltages close to the positive rail, typically (V+) - 1.3V to 500mV above the positive supply. The P-channel pair is on for inputs from 500mV below the negative supply to approximately (V+) - 1.3V.

There is a small transition region, typically (V+) - 1.5V to (V+) - 1.1V, in which both input pairs are on. This 400mV transition region can vary  $\pm 300$ mV with process variation. Thus, the transition region (both stages on) can range from (V+) - 1.8V to (V+) - 1.4V on the low end, up to (V+) - 1.2V to (V+) - 0.8V on the high end. Within the 400mV transition region PSRR, CMRR, offset voltage, offset drift, and THD may be degraded compared to operation outside this region.

A double-folded cascode adds the signal from the two input pairs and presents a differential signal to the class AB output stage. Normally, input bias current is approximately 200fA, however, input voltages exceeding the power supplies by

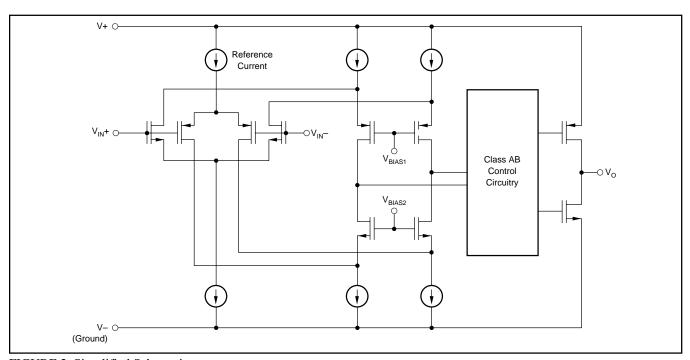


FIGURE 2. Simplified Schematic.



more than 500mV can cause excessive current to flow in or out of the input pins. Momentary voltages greater than 500mV beyond the power supply can be tolerated if the current on the input pins is limited to 10mA. This is easily accomplished with an input resistor, as shown in Figure 3. Many input signals are inherently current-limited to less than 10mA, therefore, a limiting resistor is not required.

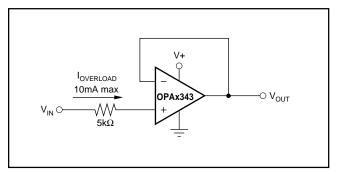


FIGURE 3. Input Current Protection for Voltages Exceeding the Supply Voltage.

#### **RAIL-TO-RAIL OUTPUT**

A class AB output stage with common-source transistors is used to achieve rail-to-rail output. For light resistive loads (>50k $\Omega$ ), the output voltage is typically a few millivolts from the supply rails. With moderate resistive loads (2k $\Omega$  to 50k $\Omega$ ), the output can swing to within a few tens of millivolts from the supply rails and maintain high open-loop gain. See the typical performanc curve "Output Voltage Swing vs Output Current."

#### **CAPACITIVE LOAD AND STABILITY**

OPA343 series op amps can drive a wide range of capacitive loads. However, all op amps under certain conditions may become unstable. Op amp configuration, gain, and load value are just a few of the factors to consider when determining stability. An op amp in unity gain configuration is the most susceptible to the effects of capacitive load. The

capacitive load reacts with the op amp's output resistance, along with any additional load resistance, to create a pole in the small-signal response which degrades the phase margin. In unity gain, OPA343 series op amps perform well, with a pure capacitive load up to approximately 1000pF. Increasing gain enhances the amplifier's ability to drive more capacitance. See the typical performance curve "Small-Signal Overshoot vs Capacitive Load."

One method of improving capacitive load drive in the unity gain configuration is to insert a  $10\Omega$  to  $20\Omega$  resistor in series with the output, as shown in Figure 4. This significantly reduces ringing with large capacitive loads. However, if there is a resistive load in parallel with the capacitive load,  $R_S$  creates a voltage divider. This introduces a dc error at the output and slightly reduces output swing. This error may be insignificant. For instance, with  $R_L=10 k\Omega$  and  $R_S=20\Omega$ , there is only about a 0.2% error at the output.

#### **DRIVING A/D CONVERTERS**

OPA343 series op amps are optimized for driving medium speed (up to 100kHz) sampling A/D converters. However, they also offer excellent performance for higher-speed converters. The OPA343 series provides an effective means of buffering the A/D's input capacitance and resulting charge injection while providing signal gain. For applications requiring high accuracy, the OPA340 series is recommended.

Figures 5 and 6 show the OPA343 driving an ADS7816. The ADS7816 is a 12-bit, micro-power sampling converter in the tiny MSOP-8 package. When used with the miniature package options of the OPA343 series, the combination is ideal for space-limited and low-power applications. For further information consult the ADS7816 data sheet.

With the OPA343 in a noninverting configuration, an RC network at the amplifier's output can be used to filter high frequency noise in the signal (see Figure 5). In the inverting configuration, filtering may be accomplished with a capacitor across the feedback resistor (see Figure 6).

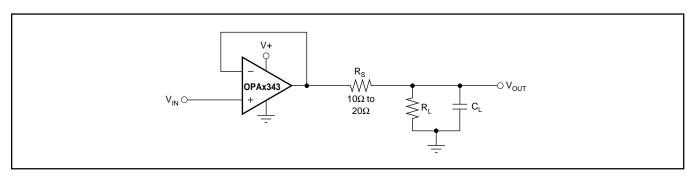


FIGURE 4. Series Resistor in Unity-Gain Configuration Improves Capacitive Load Drive.



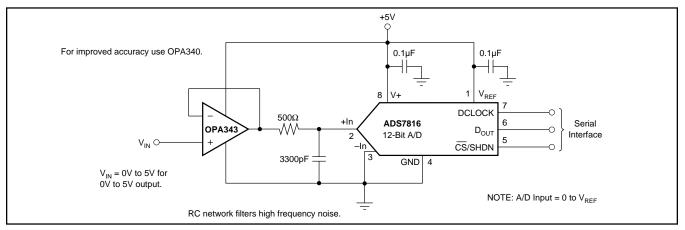


FIGURE 5. OPA343 in Noninverting Configuration Driving ADS7816.

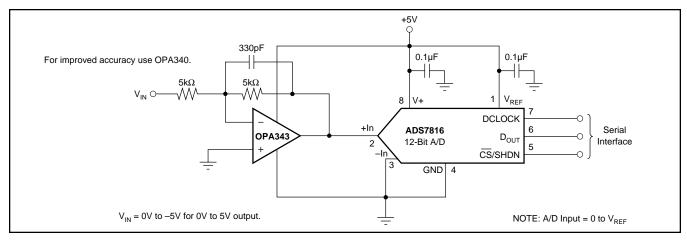


FIGURE 6. OPA343 in Inverting Configuration Driving ADS7816.

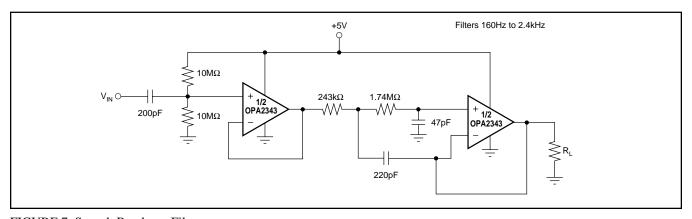


FIGURE 7. Speech Bandpass Filter.

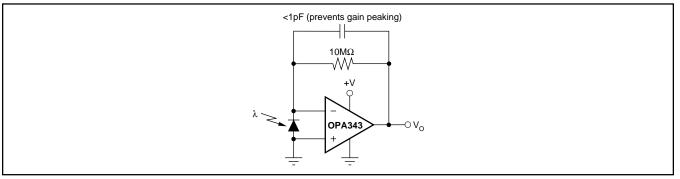


FIGURE 8. Transimpedance Amplifier.



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### **PACKAGING INFORMATION**

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	(3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
OPA2343EA/250	Active	Production	VSSOP (DGK)   8	250   SMALL T&R	Yes	NIPDAU   SN   NIPDAUAG	Level-2-260C-1 YEAR	-40 to 85	C43
OPA2343EA/250.B	Active	Production	VSSOP (DGK)   8	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	C43
OPA2343EA/250G4	Active	Production	VSSOP (DGK)   8	250   SMALL T&R	Yes	NIPDAUAG	Level-2-260C-1 YEAR	-40 to 85	C43
OPA2343EA/250G4.B	Active	Production	VSSOP (DGK)   8	250   SMALL T&R	Yes	NIPDAUAG	Level-2-260C-1 YEAR	-40 to 85	C43
OPA2343EA/2K5	Active	Production	VSSOP (DGK)   8	2500   LARGE T&R	Yes	NIPDAU   SN   NIPDAUAG	Level-2-260C-1 YEAR	-40 to 85	C43
OPA2343EA/2K5.B	Active	Production	VSSOP (DGK)   8	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	C43
OPA2343EA/2K5G4	Active	Production	VSSOP (DGK)   8	2500   LARGE T&R	Yes	NIPDAUAG	Level-2-260C-1 YEAR	-40 to 85	C43
OPA2343EA/2K5G4.B	Active	Production	VSSOP (DGK)   8	2500   LARGE T&R	Yes	NIPDAUAG	Level-2-260C-1 YEAR	-40 to 85	C43
OPA2343UA	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 2343UA
OPA2343UA.B	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 2343UA
OPA2343UA/2K5	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 2343UA
OPA2343UA/2K5.B	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 2343UA
OPA2343UAG4	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 2343UA
OPA2343UAG4.B	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 2343UA
OPA343NA/250	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	B43
OPA343NA/250.B	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	B43
OPA343NA/250G4	Active	Production	SOT-23 (DBV)   5	250   SMALL T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	B43
OPA343NA/3K	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	B43
OPA343NA/3K.B	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	B43
OPA343NA/3KG4	Active	Production	SOT-23 (DBV)   5	3000   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	B43
OPA343UA	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 343UA
OPA343UA.B	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 343UA





www.ti.com 2-Dec-2025

Orderable part number	Status (1)	Material type	Package   Pins	Package qty   Carrier	(3)	Lead finish/ Ball material	MSL rating/ Peak reflow	Op temp (°C)	Part marking (6)
OPA343UA/2K5	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 343UA
OPA343UA/2K5.B	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 343UA
OPA4343EA/250	Active	Production	SSOP (DBQ)   16	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343EA
OPA4343EA/250.B	Active	Production	SSOP (DBQ)   16	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343EA
OPA4343EA/2K5	Active	Production	SSOP (DBQ)   16	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343EA
OPA4343EA/2K5.B	Active	Production	SSOP (DBQ)   16	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343EA
OPA4343EA/2K5G4	Active	Production	SSOP (DBQ)   16	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343EA
OPA4343EA/2K5G4.B	Active	Production	SSOP (DBQ)   16	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343EA
OPA4343NA/250	Active	Production	TSSOP (PW)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343NA
OPA4343NA/250.B	Active	Production	TSSOP (PW)   14	250   SMALL T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343NA
OPA4343NA/2K5	Active	Production	TSSOP (PW)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343NA
OPA4343NA/2K5.B	Active	Production	TSSOP (PW)   14	2500   LARGE T&R	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA 4343NA
OPA4343UA	Active	Production	SOIC (D)   14	50   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA4343UA
OPA4343UA.B	Active	Production	SOIC (D)   14	50   TUBE	Yes	NIPDAU	Level-2-260C-1 YEAR	-40 to 85	OPA4343UA
OPA4343UA/2K5	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	OPA4343UA
OPA4343UA/2K5.B	Active	Production	SOIC (D)   14	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	-40 to 85	OPA4343UA

<sup>(1)</sup> Status: For more details on status, see our product life cycle.

<sup>(2)</sup> Material type: When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.



## PACKAGE OPTION ADDENDUM

www.ti.com 2-Dec-2025

- (3) RoHS values: Yes, No, RoHS Exempt. See the TI RoHS Statement for additional information and value definition.
- (4) Lead finish/Ball material: Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.
- (5) MSL rating/Peak reflow: The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.
- (6) Part marking: There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

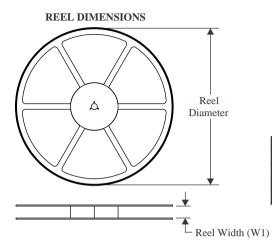
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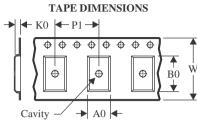
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www.ti.com 7-Oct-2025

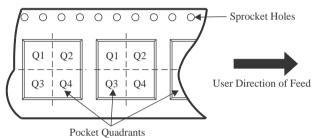
#### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
OPA2343EA/250	VSSOP	DGK	8	250	330.0	12.4	5.25	3.35	1.25	8.0	12.0	Q1
OPA2343EA/250	VSSOP	DGK	8	250	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2343EA/250G4	VSSOP	DGK	8	250	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2343EA/2K5	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2343EA/2K5G4	VSSOP	DGK	8	2500	330.0	12.4	5.3	3.4	1.4	8.0	12.0	Q1
OPA2343UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA343NA/250	SOT-23	DBV	5	250	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
OPA343NA/250	SOT-23	DBV	5	250	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
OPA343NA/3K	SOT-23	DBV	5	3000	179.0	8.4	3.2	3.2	1.4	4.0	8.0	Q3
OPA343NA/3K	SOT-23	DBV	5	3000	178.0	9.0	3.23	3.17	1.37	4.0	8.0	Q3
OPA343UA/2K5	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA4343EA/250	SSOP	DBQ	16	250	180.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA4343EA/2K5	SSOP	DBQ	16	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA4343EA/2K5G4	SSOP	DBQ	16	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
OPA4343NA/250	TSSOP	PW	14	250	180.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1
OPA4343NA/2K5	TSSOP	PW	14	2500	330.0	12.4	6.9	5.6	1.6	8.0	12.0	Q1



# PACKAGE MATERIALS INFORMATION

www.ti.com 7-Oct-2025

	Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
ĺ	OPA4343UA/2K5	SOIC	D	14	2500	330.0	16.4	6.5	9.0	2.1	8.0	16.0	Q1



www.ti.com 7-Oct-2025



\*All dimensions are nominal

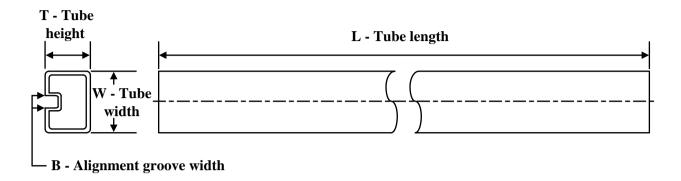
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
OPA2343EA/250	VSSOP	DGK	8	250	366.0	364.0	50.0
OPA2343EA/250	VSSOP	DGK	8	250	353.0	353.0	32.0
OPA2343EA/250G4	VSSOP	DGK	8	250	366.0	364.0	50.0
OPA2343EA/2K5	VSSOP	DGK	8	2500	353.0	353.0	32.0
OPA2343EA/2K5G4	VSSOP	DGK	8	2500	366.0	364.0	50.0
OPA2343UA/2K5	SOIC	D	8	2500	353.0	353.0	32.0
OPA343NA/250	SOT-23	DBV	5	250	203.0	203.0	35.0
OPA343NA/250	SOT-23	DBV	5	250	180.0	180.0	18.0
OPA343NA/3K	SOT-23	DBV	5	3000	203.0	203.0	35.0
OPA343NA/3K	SOT-23	DBV	5	3000	180.0	180.0	18.0
OPA343UA/2K5	SOIC	D	8	2500	353.0	353.0	32.0
OPA4343EA/250	SSOP	DBQ	16	250	213.0	191.0	35.0
OPA4343EA/2K5	SSOP	DBQ	16	2500	353.0	353.0	32.0
OPA4343EA/2K5G4	SSOP	DBQ	16	2500	353.0	353.0	32.0
OPA4343NA/250	TSSOP	PW	14	250	213.0	191.0	35.0
OPA4343NA/2K5	TSSOP	PW	14	2500	353.0	353.0	32.0
OPA4343UA/2K5	SOIC	D	14	2500	353.0	353.0	32.0

# **PACKAGE MATERIALS INFORMATION**



www.ti.com 7-Oct-2025

#### **TUBE**



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
OPA2343UA	D	SOIC	8	75	506.6	8	3940	4.32
OPA2343UA.B	D	SOIC	8	75	506.6	8	3940	4.32
OPA2343UAG4	D	SOIC	8	75	506.6	8	3940	4.32
OPA2343UAG4.B	D	SOIC	8	75	506.6	8	3940	4.32
OPA343UA	D	SOIC	8	75	506.6	8	3940	4.32
OPA343UA.B	D	SOIC	8	75	506.6	8	3940	4.32
OPA4343UA	D	SOIC	14	50	506.6	8	3940	4.32
OPA4343UA.B	D	SOIC	14	50	506.6	8	3940	4.32

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